



STP4NK80Z - STP4NK80ZFP STD4NK80Z - STD4NK80Z-1

N-channel 800V - 3Ω - 3A - TO-220/TO-220FP/DPAK/IPAK
Zener - Protected SuperMESH™ MOSFET

General features

Type	V_{DSS} (@ T_{jmax})	$R_{DS(on)}$	I_D
STP4NK80Z	800 V	< 3.5 Ω	3 A
STP4NK80ZFP	800 V	< 3.5 Ω	3 A
STD4NK80Z	800 V	< 3.5 Ω	3 A
STD4NK80Z-1	800 V	< 3.5 Ω	3 A

- Extremely high dv/dt capability
- 100% avalanche tested
- Gate charge minimized
- Very low intrinsic capacitances
- Very good manufacturing repeatability

Description

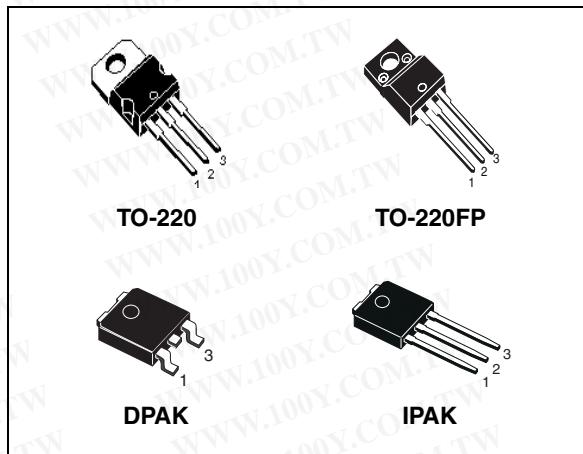
The SuperMESH™ series is obtained through an extreme optimization of ST's well established strip-based PowerMESH™ layout. In addition to pushing on-resistance significantly down, special care is taken to ensure a very good dv/dt capability for the most demanding applications. Such series complements ST full range of high voltage MOSFETs including revolutionary MDmesh™ products.

Applications

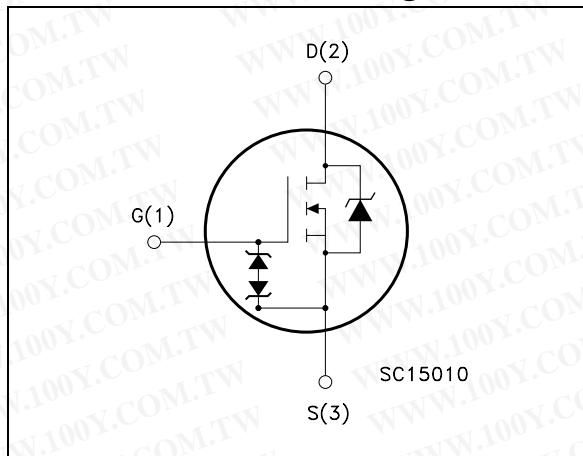
- Switching application

Order codes

Part number	Marking	Package	Packaging
STP4NK80Z	P4NK80Z	TO-220	Tube
STP4NK80ZFP	P4NK80ZFP	TO-220FP	Tube
STD4NK80ZT4	D4NK80Z	DPAK	Tape & reel
STD4NK80Z-1	D4NK80Z	IPAK	Tube



Internal schematic diagram



Contents

1	Electrical ratings	3
1.1	Protection features of gate-to-source zener diodes	4
2	Electrical characteristics	5
2.1	Electrical characteristics (curves)	7
3	Test circuit	10
4	Package mechanical data	11
5	Packaging mechanical data	16
6	Revision history	17

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1 Electrical ratings

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Table 1. Absolute maximum ratings

Symbol	Parameter	Value		Unit
		TO-220/DPAK/ IPAK	TO-220FP	
V_{DS}	Drain-source voltage ($V_{GS} = 0$)	800		V
V_{GS}	Gate-source voltage	± 30		V
I_D	Drain current (continuous) at $T_C = 25^\circ\text{C}$	3	3 ⁽¹⁾	A
I_D	Drain current (continuous) at $T_C = 100^\circ\text{C}$	1.89	1.89 ⁽¹⁾	A
$I_{DM}^{(2)}$	Drain current (pulsed)	12	12 ⁽¹⁾	A
P_{TOT}	Total dissipation at $T_C = 25^\circ\text{C}$	80	25	W
	Derating factor	0.64	0.21	W/ $^\circ\text{C}$
$V_{ESD(G-S)}$	Gate source ESD (HBM-C=100pF, $R=1.5\text{ k}\Omega$)	3000		V
dv/dt ⁽³⁾	Peak diode recovery voltage slope	4.5		V/ns
V_{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink ($t=1\text{ s}; T_c = 25^\circ\text{C}$)	-	2500	V
T_J T_{stg}	Operating junction temperature Storage temperature	-55 to 150		$^\circ\text{C}$

1. Limited only by maximum temperature allowed
2. Pulse width limited by safe operating area
3. $I_{SD} \leq 4\text{ A}$, $dI/dt \leq 200\text{ A}/\mu\text{s}$, $V_{DD} \leq V_{(BR)DSS}$, $T_j \leq T_{JMAX}$.

Table 2. Thermal data

Symbol	Parameter	Value			Unit
		TO-220	TO-220FP	DPAK IPAK	
$R_{thj-case}$	Thermal resistance junction-case max	1.56	5	1.56	$^\circ\text{C/W}$
R_{thj-a}	Thermal resistance junction-ambient max	62.5		100	$^\circ\text{C/W}$
T_I	Maximum lead temperature for soldering purpose	300			$^\circ\text{C}$

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I_{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T_j Max)	3	A
E_{AS}	Single pulse avalanche energy (starting $T_j=25^\circ C$, $I_d=I_{ar}$, $V_{dd}=50V$)	190	mJ

Table 4. Gate-source zener diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
BV_{GSO}	Gate-source breakdown voltage	$I_{GS}=\pm 1mA$ (Open Drain)	30			V

1.1

Protection features of gate-to-source zener diodes

The built-in back-to-back Zener diodes have specifically been designed to enhance not only the device's ESD capability, but also to make them safely absorb possible voltage transients that may occasionally be applied from gate to source. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.

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2

Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

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Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1mA, V _{GS} = 0	800			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = Max rating, V _{DS} = Max rating, T _c = 125°C			1 50	μA μA
I _{GSS}	Gate body leakage current (V _{GS} = 0)	V _{GS} = ± 20V			±10	μA
V _{GS(th)}	Gate threshold voltage	V _{DS} = V _{GS} , I _D = 50μA	3	3.75	4.5	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10V, I _D = 1.5 A		3	3.5	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15V, I _D = 1.5A		2.9		s
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 25V, f = 1 MHz, V _{GS} = 0		575 67 13		pF pF pF
C _{osseq} ⁽²⁾	Equivalent output capacitance	V _{GS} = 0, V _{DS} = 0V to 400V		60		pF
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Off-voltage rise time Fall time	V _{DD} = 400 V, I _D = 1.5 A, R _G = 4.7Ω, V _{GS} = 10V (see Figure 18)		13 12 35 32		ns ns ns ns
t _{r(Voff)} t _r t _c	Off-voltage rise time Fall time Cross-over time	V _{DD} = 640 V, I _D = 3 A, R _G = 4.7Ω, V _{GS} = 10V (see Figure 16)		18 7.5 25		ns ns ns
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V _{DD} = 640V, I _D = 3 A V _{GS} = 10V (see Figure 19)		22.5 4.2 11.3		nC nC nC

1. Pulsed: pulse duration = 300μs, duty cycle 1.5%
2. C_{oss eq.} is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min	Typ.	Max	Unit
I_{SD}	Source-drain current			3	A	
$I_{SDM}^{(1)}$	Source-drain current (pulsed)			12	A	
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 3 \text{ A}, V_{GS}=0$		1.6	V	
t_{rr} Q_{rr} I_{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 3 \text{ A},$ $di/dt = 100\text{A}/\mu\text{s},$ $V_{DD}=80 \text{ V}, T_j=150^\circ\text{C}$ (see <i>Figure 20</i>)		400 1520 7.6		ns μC A

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration=300 μs , duty cycle 1.5%

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2.1 Electrical characteristics (curves)

Figure 1. Safe operating area for TO-220/DPAK/IPAK

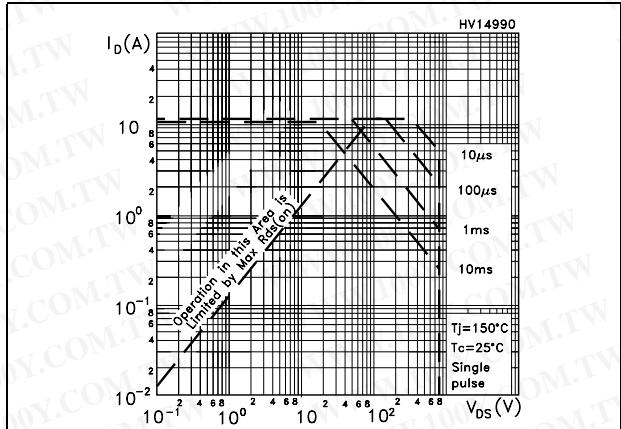


Figure 2. Thermal impedance for TO-220/DPAK/IPAK

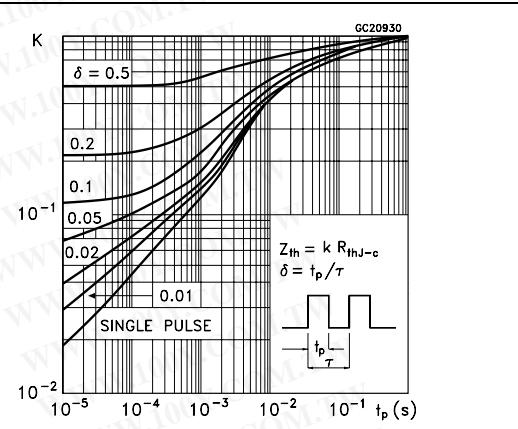


Figure 3. Safe operating area for TO-220FP

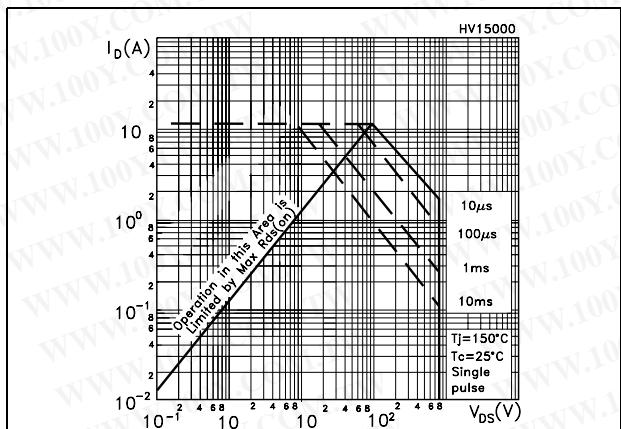


Figure 4. Thermal impedance for TO-220FP

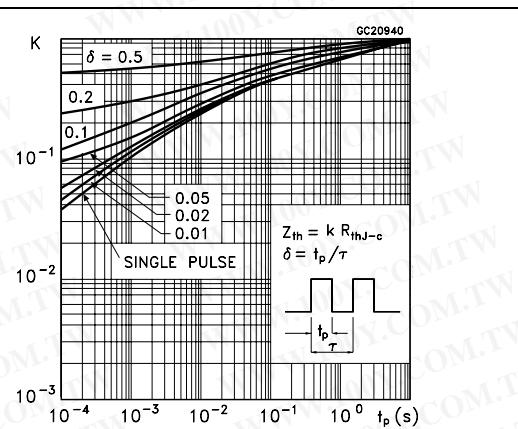


Figure 5. Output characteristics

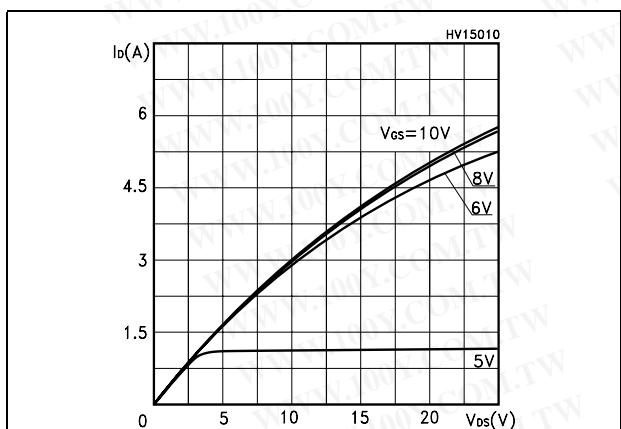


Figure 6. Transfer characteristics

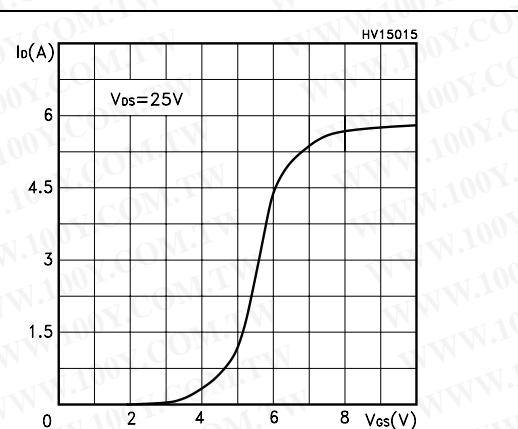


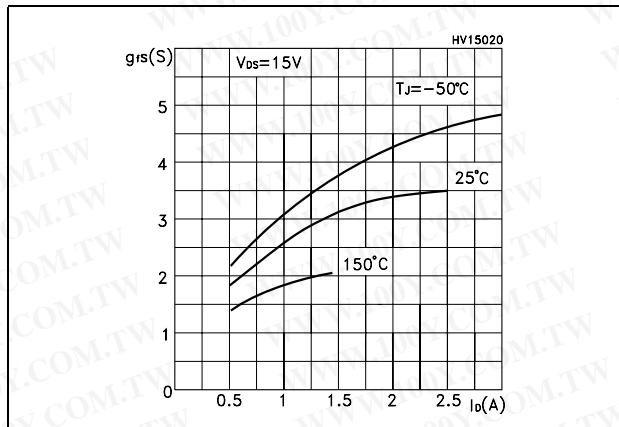
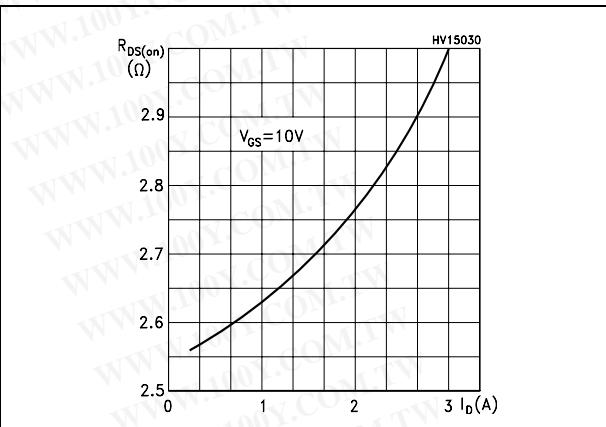
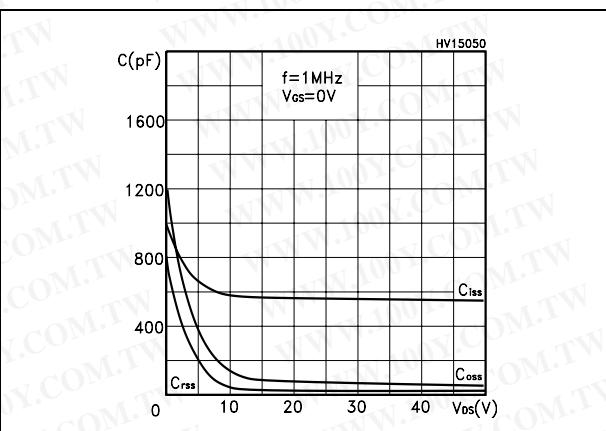
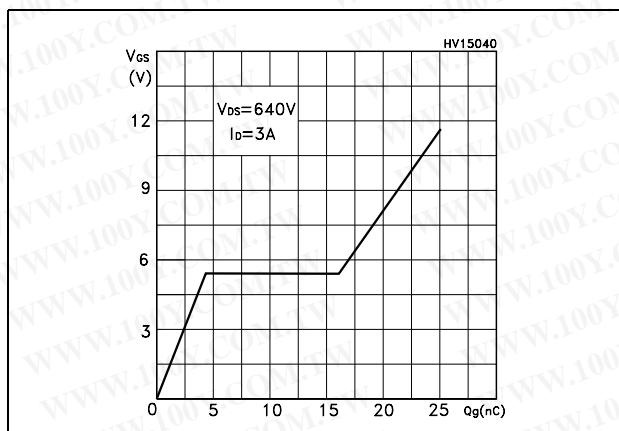
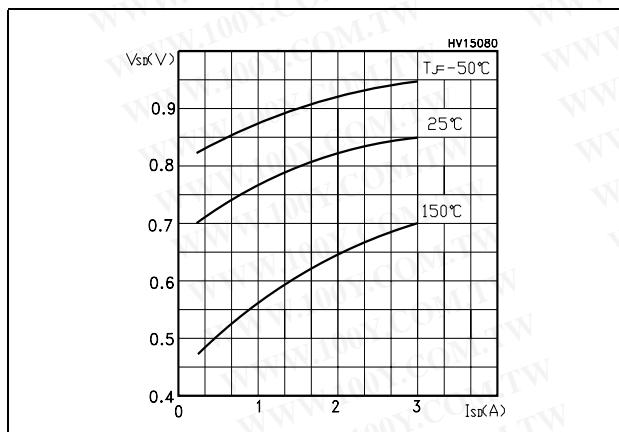
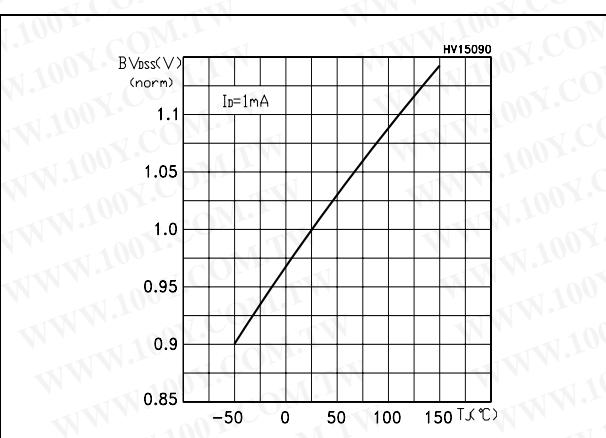
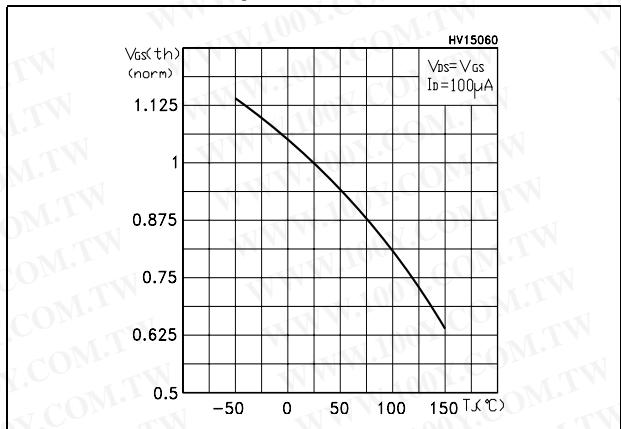
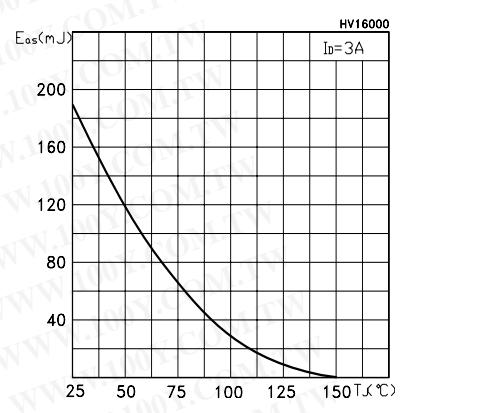
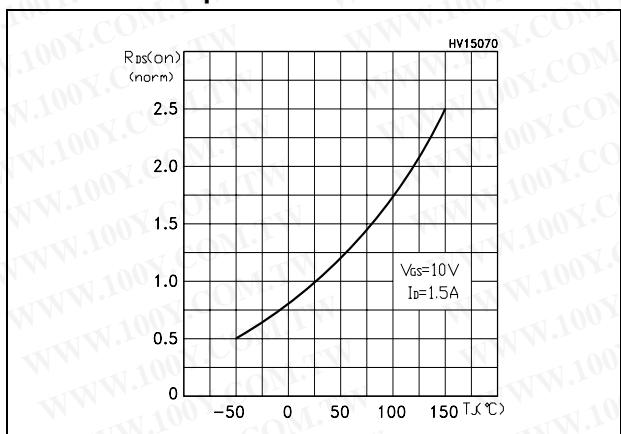
Figure 7. Transconductance**Figure 8. Static drain-source on resistance****Figure 9. Gate charge vs gate-source voltage** **Figure 10. Capacitance variations****Figure 11. Source-drain diode forward characteristics****Figure 12. Normalized BVdss vs temperature**

Figure 13. Normalized gate threshold voltage vs temperature**Figure 14. Avalanche energy vs temperature****Figure 15. Normalized on resistance vs temperature**

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3 Test circuit

Figure 16. Unclamped Inductive load test circuit

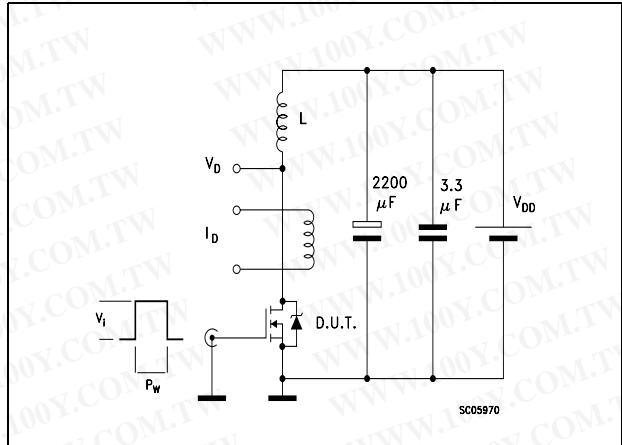


Figure 17. Unclamped Inductive waveform

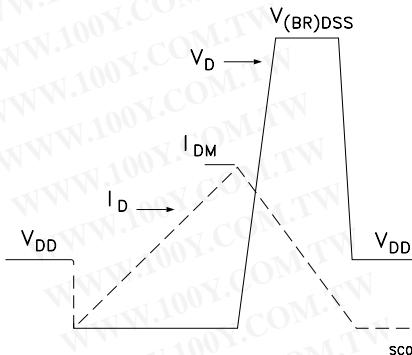


Figure 18. Switching times test circuit for resistive load

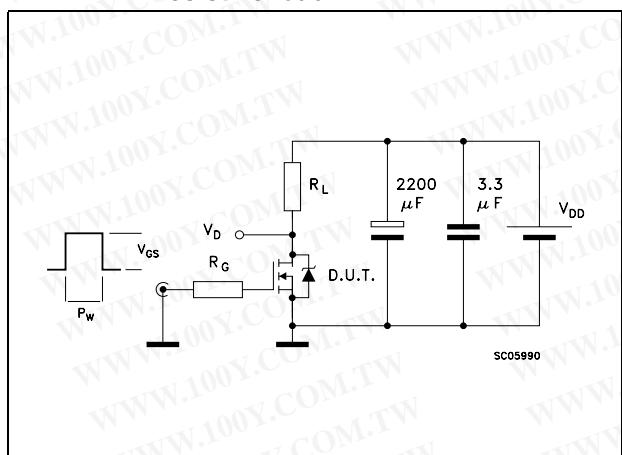


Figure 19. Gate charge test circuit

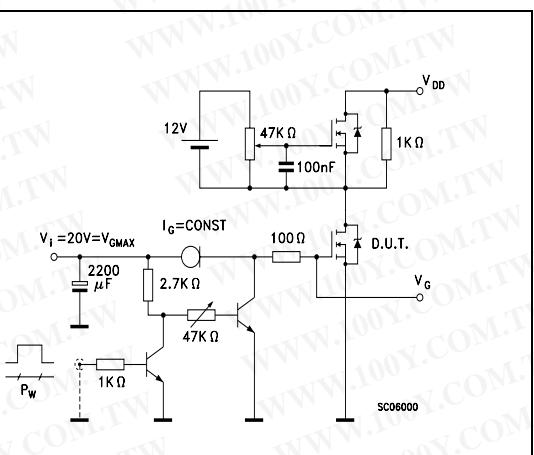
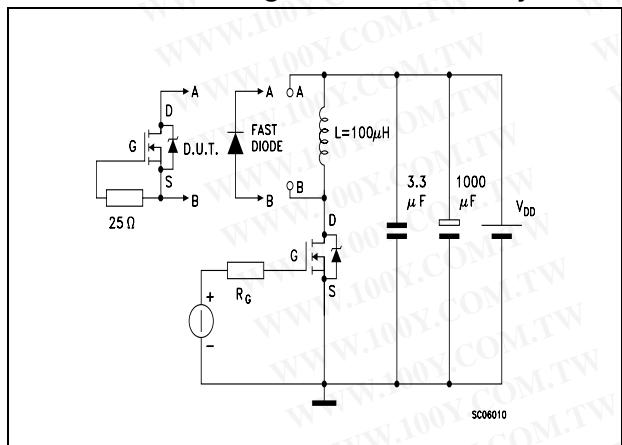


Figure 20. Test circuit for inductive load switching and diode recovery times



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4 Package mechanical data

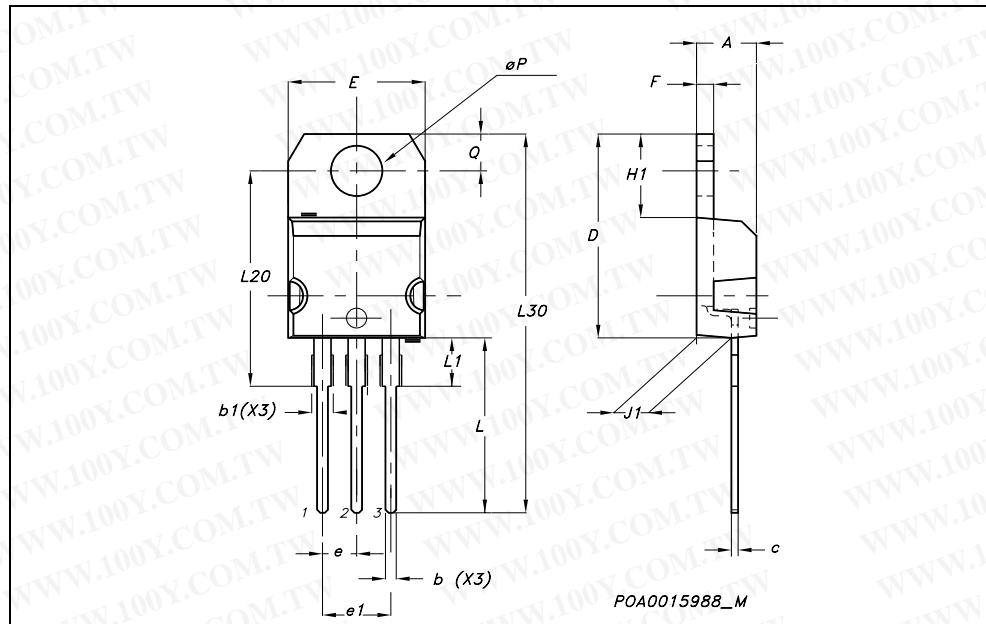
In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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TO-220 MECHANICAL DATA

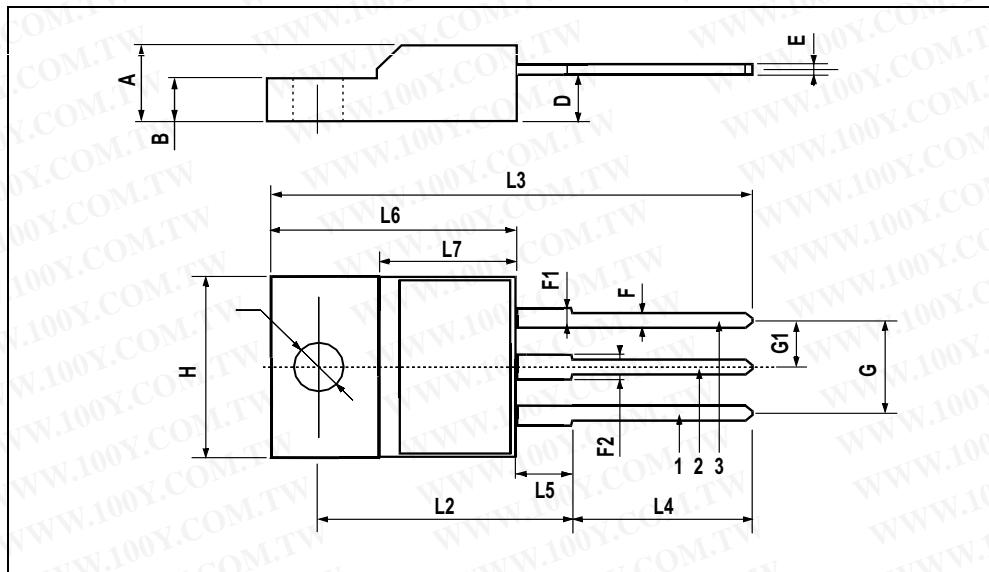
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.15		1.70	0.045		0.066
c	0.49		0.70	0.019		0.027
D	15.25		15.75	0.60		0.620
E	10		10.40	0.393		0.409
e	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
ϕP	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



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TO-220FP MECHANICAL DATA

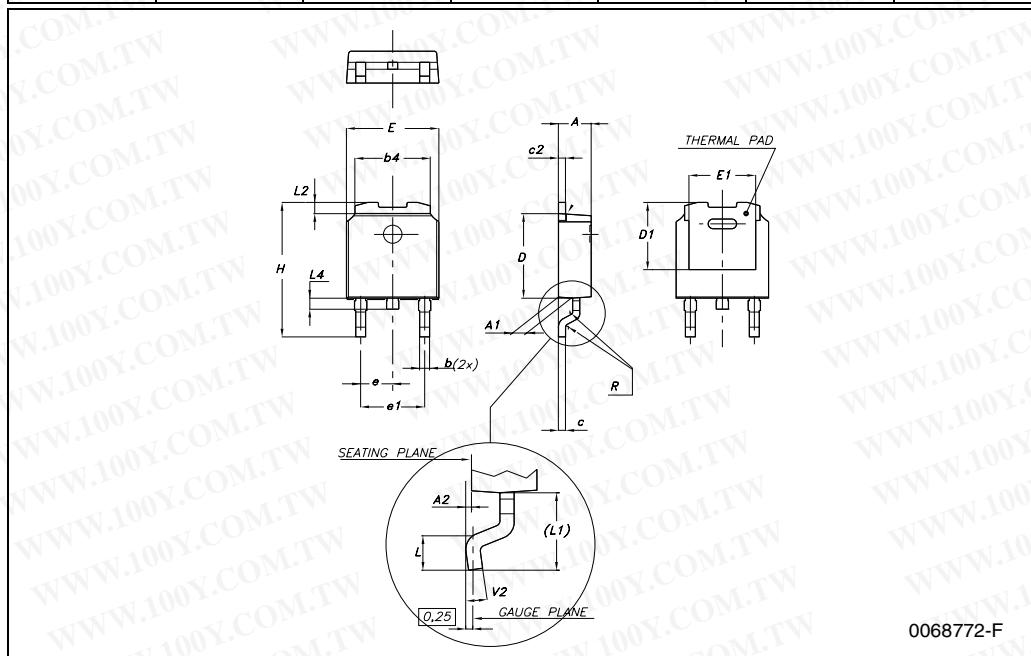
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.4		4.6	0.173		0.181
B	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
H	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	.0385		0.417
L5	2.9		3.6	0.114		0.141
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126



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DPAK MECHANICAL DATA

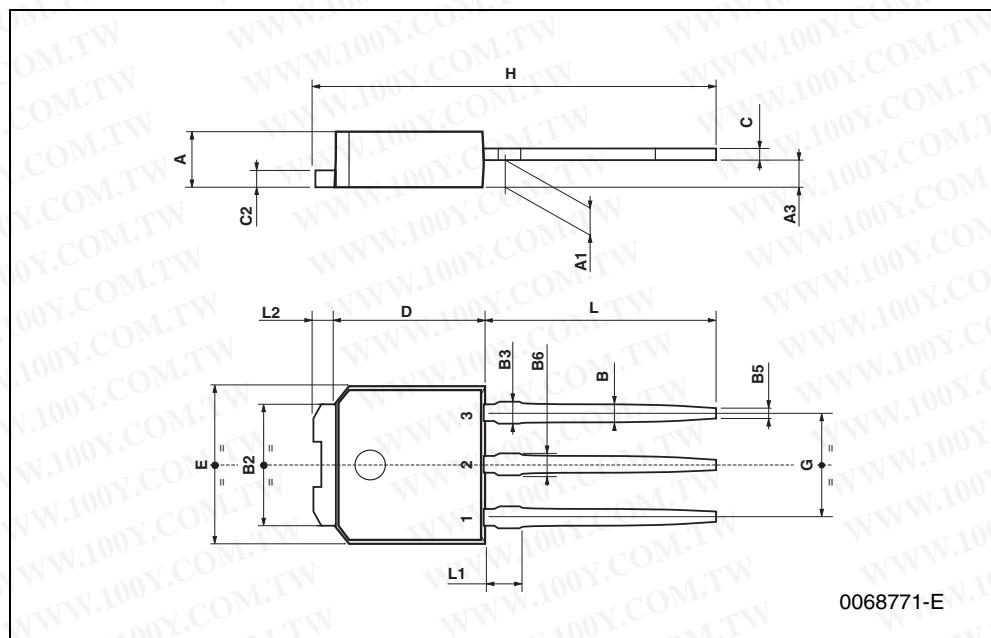
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	2.2		2.4	0.086		0.094
A1	0.9		1.1	0.035		0.043
A2	0.03		0.23	0.001		0.009
B	0.64		0.9	0.025		0.035
b4	5.2		5.4	0.204		0.212
C	0.45		0.6	0.017		0.023
C2	0.48		0.6	0.019		0.023
D	6		6.2	0.236		0.244
D1		5.1			0.200	
E	6.4		6.6	0.252		0.260
E1		4.7			0.185	
e		2.28			0.090	
e1	4.4		4.6	0.173		0.181
H	9.35		10.1	0.368		0.397
L	1			0.039		
(L1)		2.8			0.110	
L2		0.8			0.031	
L4	0.6		1	0.023		0.039
R		0.2			0.008	
V2	0°		8°	0°		8°



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TO-251 (IPAK) MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	2.2		2.4	0.086		0.094
A1	0.9		1.1	0.035		0.043
A3	0.7		1.3	0.027		0.051
B	0.64		0.9	0.025		0.031
B2	5.2		5.4	0.204		0.212
B3			0.85			0.033
B5		0.3			0.012	
B6			0.95			0.037
C	0.45		0.6	0.017		0.023
C2	0.48		0.6	0.019		0.023
D	6		6.2	0.236		0.244
E	6.4		6.6	0.252		0.260
G	4.4		4.6	0.173		0.181
H	15.9		16.3	0.626		0.641
L	9		9.4	0.354		0.370
L1	0.8		1.2	0.031		0.047
L2		0.8	1		0.031	0.039

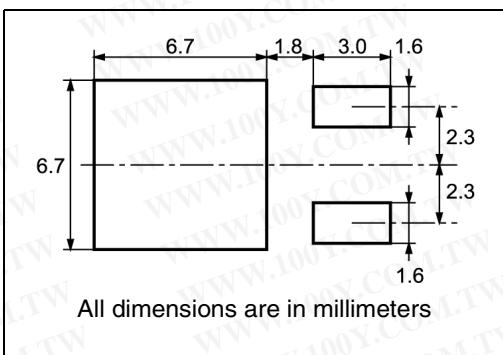


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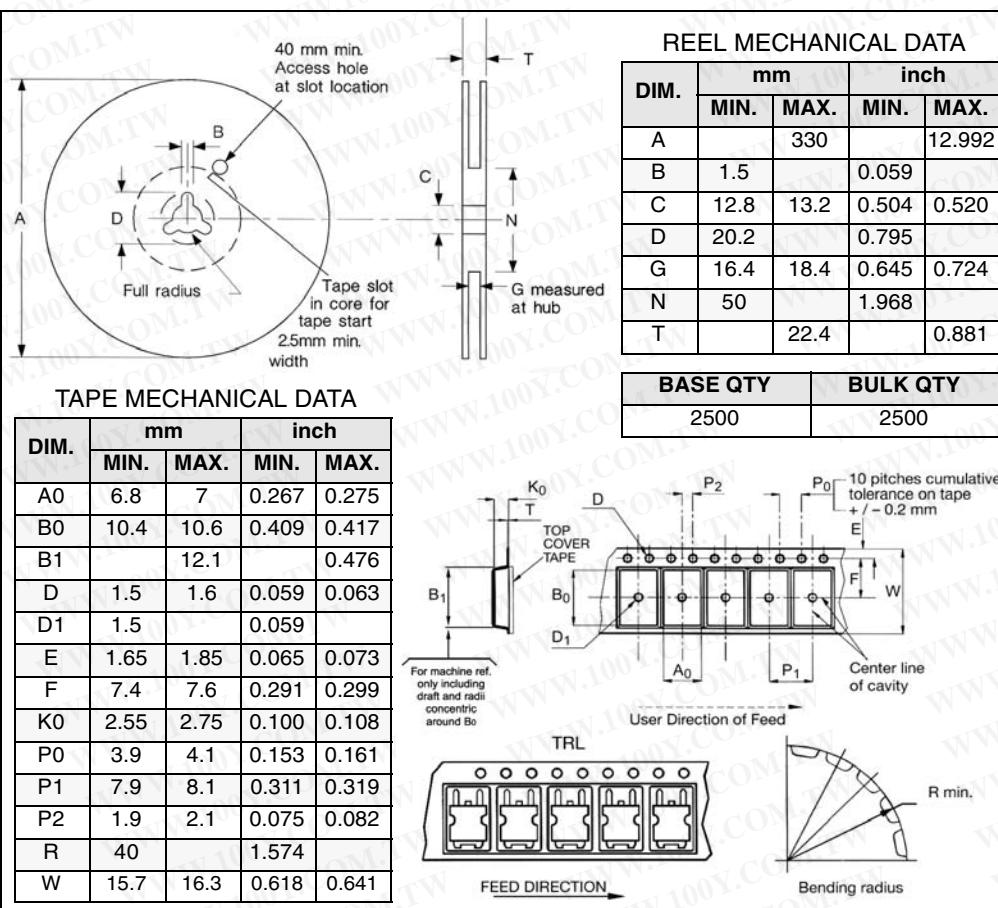
Packaging mechanical data

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DPAK FOOTPRINT



TAPE AND REEL SHIPMENT



6 Revision history

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Table 8. Revision history

Date	Revision	Changes
30-Mar-2005	5	Preliminary version
06-Sep-2005	6	Final version
21Jan-2006	7	Inserted ecopack indication
16-Aug-2006	8	New template, no content change

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